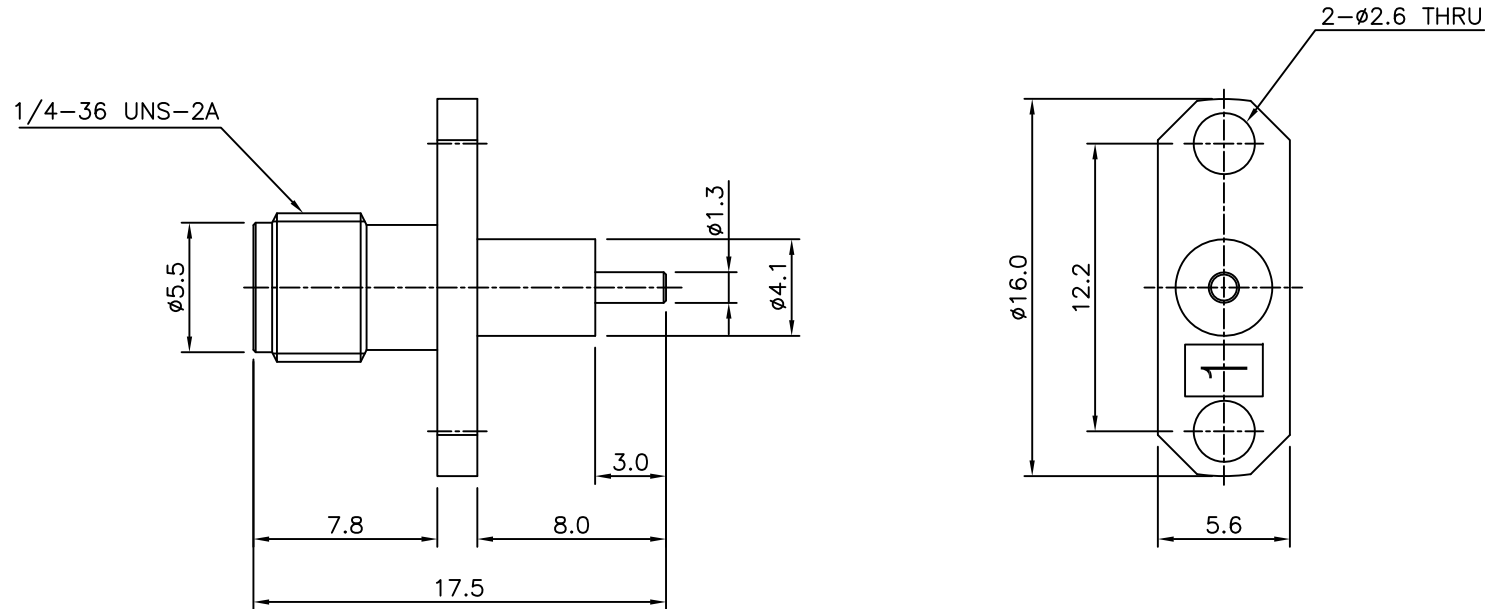


REVISION					
REV	DESCRIPTION	DRAWN	APPR	DATE	
IR	Initial Registration	I.C.KIM	J.H.YOUN	2011.08.17.	
1	[고객사 요청사항으로 각인 삭제]	I.C.KIM		2011.10.13.	
2	절연체 공용화로 인한 코드 변경	S.Y.EUN	I.C.KIM	2020.12.24.	
3	PIN 공용화 제품 적용으로 인한 코드 변경	S.Y.EUN	S.H.KIM	2022.08.23.	



2	3	INSULATOR	1	TEFLON		DIN02077-N/1 DIN00121-N/1
3	2	CONTACT	1	BeCu	Gold Plate	DCT01423-5/1 DCT00193-5/1
1	1	BODY	1	ZnDC	Nickel Plate	DBD00347-5/3
	NO.	DESCRIPTION	Q'TY	MATERIAL	PLATING	CODE

TOLERANCE	Decimal ±0.2	DATE 2022. 08. 23.			 RF & MICROWAVE TECHNOLOGY Tel : 82-32-347-8015 Fax : 82-32-347-8017	
	Angle ±1°	APPROVED BY S.H.KIM				
MATERIAL _____		CHECKED BY		TITLE SMA50 SOLDER END JS-2H		
		DRAWN BY S.Y.EUN				
FINISH _____		SCALE 3/1	UNIT mm		A4	DWG NO. CN01108-7/2
						REVISION 3